IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
1752-21.1					Form Type Distribute						rials and Mfg Information					
Supplier	Information															
Company name* Company un				nique ID			Unique ID Authority					Respon	Response Date*			
onsemi												2023-00	2023-06-08			
Contact N	ame		Title - Contact]	Phone - Contact*					Email -	Email - Contact*			
Product-I	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
Authorize	d Representative*		Title - Representative			1	Phone - Representative*					Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date Version Ma		Man	Manufacturing Site		Weight*	UOM	Ur	it Type	
		NCP4204MNTXG AMD Vr Co.		AMD Vr Controlle	roller		2023-06-08						109.58	mg	Ea	ch
Manufa	cturing Proccess Informa	tion					,			,				·		
	Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MSI		L Rating	Peak Process Body Temp		rature 1	rature Max Time at Peak		ture Nu	mber of Reflow	Cycles		
Matte Tin (Sn) - annealed CU Allo			U Alloy	y 1			260 C			30	seconds 3					
Comments																
evel 1 - m	aximum time at peak temperatu	ire during sol	dering is 10-3	0 seconds												
or more	information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a						
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.94	mg	Supplier	Silicon (Si)	7440-21-3		4.94	mg
Die Attach	0.9	mg		Epoxy resin	proprietary data		0.207	mg
			Supplier	Silver (Ag)	7440-22-4		0.693	mg
Lead Frame	52.8	mg	Supplier	Silver (Ag)	7440-22-4		0.4224	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0528	mg
			Supplier	Iron (Fe)	7439-89-6		1.3728	mg
			Supplier	Copper (Cu)	7440-50-8		50.952	mg
Mold Compound-Black	48.17	mg		Epoxy resin	proprietary data		2.4085	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2408	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		43.1121	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.4085	mg
Plating	2.63	mg	Supplier	Tin (Sn)	7440-31-5		2.63	mg
Wire Bond	0.14	mg	Supplier	Palladium (Pd)	7440-05-3		0.0014	mg
			Supplier	Copper (Cu)	7440-50-8		0.1386	mg